

SWITCHING
N-CHANNEL POWER MOS FET
INDUSTRIAL USE

DESCRIPTION

The 2SK3367 is N-Channel MOS Field Effect Transistor designed for DC/DC converter application of notebook computers.

FEATURES

- Low on-resistance
 $R_{DS(on)1} = 9.0 \text{ m}\Omega \text{ MAX. } (V_{GS} = 10 \text{ V}, I_D = 18 \text{ A})$
 $R_{DS(on)2} = 12.0 \text{ m}\Omega \text{ MAX. } (V_{GS} = 4.5 \text{ V}, I_D = 18 \text{ A})$
 $R_{DS(on)3} = 14.0 \text{ m}\Omega \text{ MAX. } (V_{GS} = 4.0 \text{ V}, I_D = 18 \text{ A})$
- Low C_{iss} : $C_{iss} = 2800 \text{ pF TYP.}$
- Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3367	TO-251
2SK3367-Z	TO-252

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ }^\circ\text{C}$)

Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	30	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	V_{GSS}	± 20	V
Drain Current (DC)	$I_D(\text{DC})$	± 36	A
Drain Current (Pulse) ^{Note}	$I_D(\text{pulse})$	± 144	A
Total Power Dissipation ($T_c = 25 \text{ }^\circ\text{C}$)	P_T	40	W
Total Power Dissipation ($T_A = 25 \text{ }^\circ\text{C}$)	P_T	1.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to + 150	$^\circ\text{C}$

Note $PW \leq 10 \mu\text{s}$, Duty cycle $\leq 1 \%$

THERMAL RESISTANCE

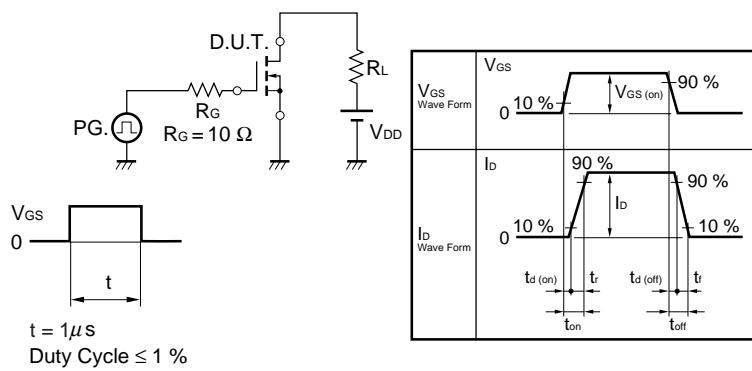
Channel to case	$R_{th(\text{ch-C})}$	3.13	$^\circ\text{C/W}$
Channel to ambient	$R_{th(\text{ch-A})}$	125	$^\circ\text{C/W}$

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 Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

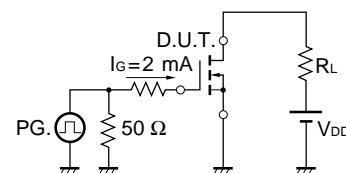
ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ C$)

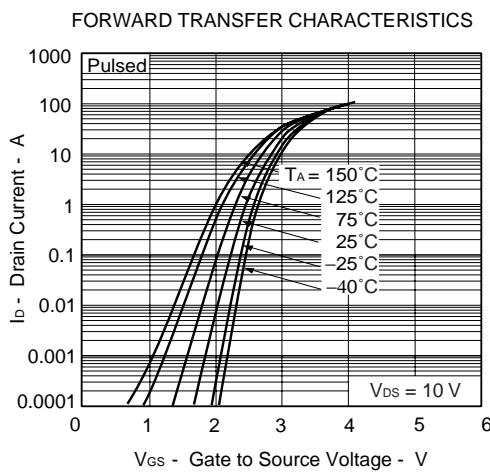
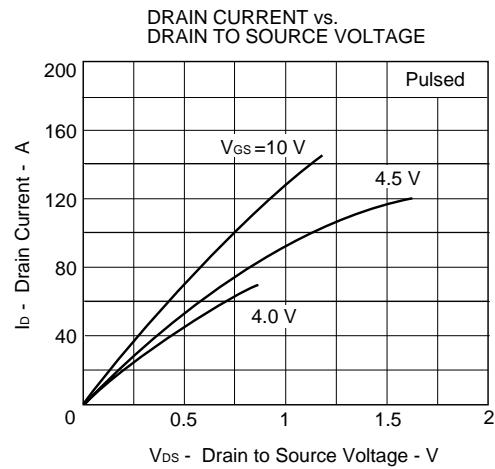
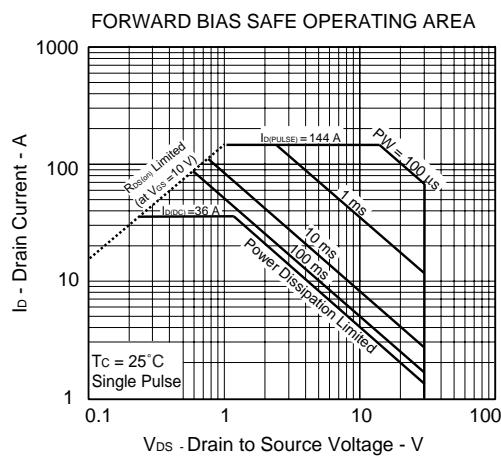
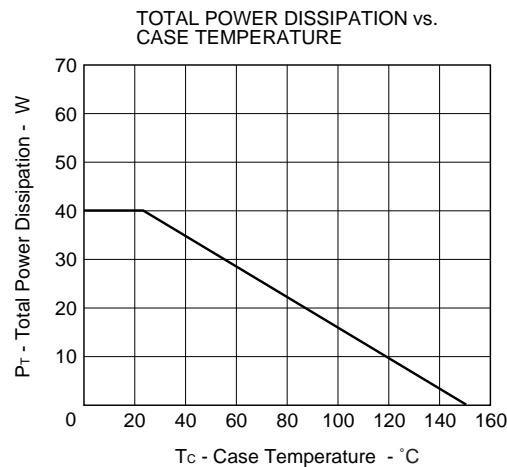
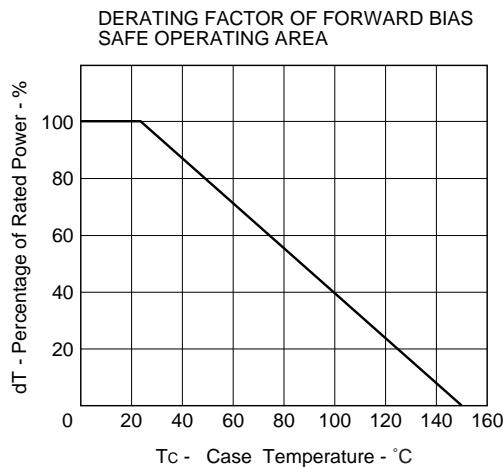
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	$R_{DS(on)1}$	$V_{GS} = 10 V, I_D = 18 A$		7.3	9.0	$m\Omega$
	$R_{DS(on)2}$	$V_{GS} = 4.5 V, I_D = 18 A$		9.0	12.0	$m\Omega$
	$R_{DS(on)3}$	$V_{GS} = 4.0 V, I_D = 18 A$		9.7	14.0	$m\Omega$
Gate to Source Cut-off Voltage	$V_{GS(off)}$	$V_{DS} = 10 V, I_D = 1 mA$	1.5	2.0	2.5	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS} = 10 V, I_D = 18 A$	13	26		S
Drain Leakage Current	I_{DSS}	$V_{DS} = 30 V, V_{GS} = 0 V$			10	μA
Gate to Source Leakage Current	I_{GSS}	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			± 10	μA
Input Capacitance	C_{iss}	$V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz$		2800		pF
Output Capacitance	C_{oss}			880		pF
Reverse Transfer Capacitance	C_{rss}			400		pF
Turn-on Delay Time	$t_{d(on)}$	$I_D = 18 A, V_{GS(on)} = 10 V, V_{DD} = 15 V, R_G = 10 \Omega$		75		ns
Rise Time	t_r			1130		ns
Turn-off Delay Time	$t_{d(off)}$			165		ns
Fall Time	t_f			210		ns
Total Gate Charge	Q_G	$I_D = 36 A, V_{DD} = 24 V, V_{GS} = 10 V$		49		nC
Gate to Source Charge	Q_{GS}			10		nC
Gate to Drain Charge	Q_{GD}			14		nC
Body Diode forward Voltage	$V_{F(S-D)}$	$I_F = 36 A, V_{GS} = 0 V$		0.95		V
Reverse Recovery Time	t_{rr}	$I_F = 36 A, V_{GS} = 0 V$ $di/dt = 100 A/\mu s$		45		ns
Reverse Recovery Charge	Q_{rr}			50		nC

TEST CIRCUIT 1 SWITCHING TIME

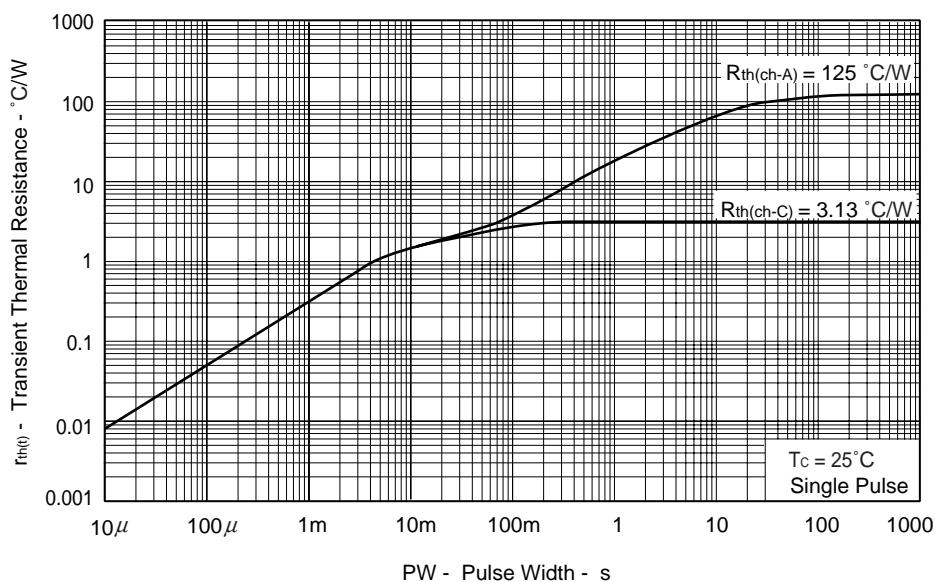


TEST CIRCUIT 2 GATE CHARGE

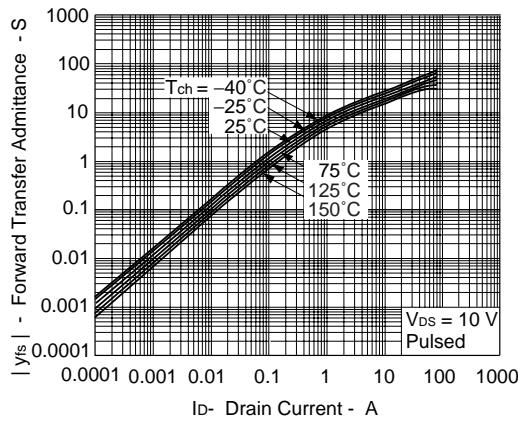


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

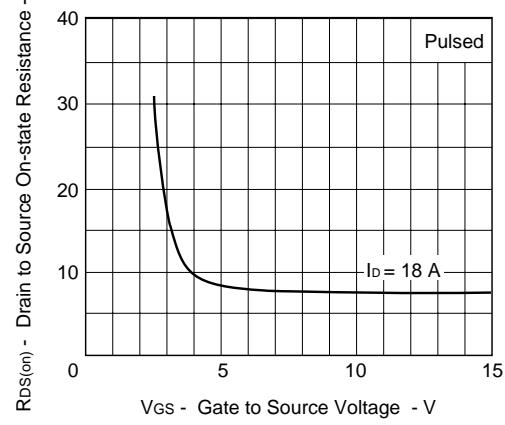
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



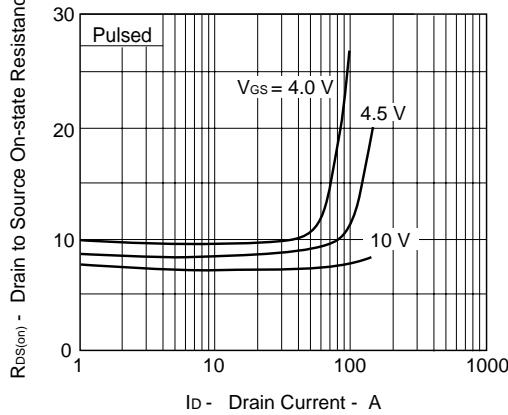
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



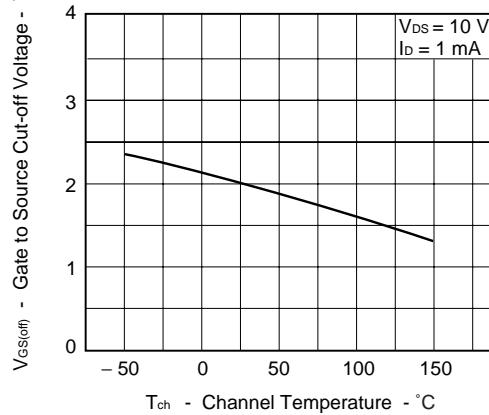
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

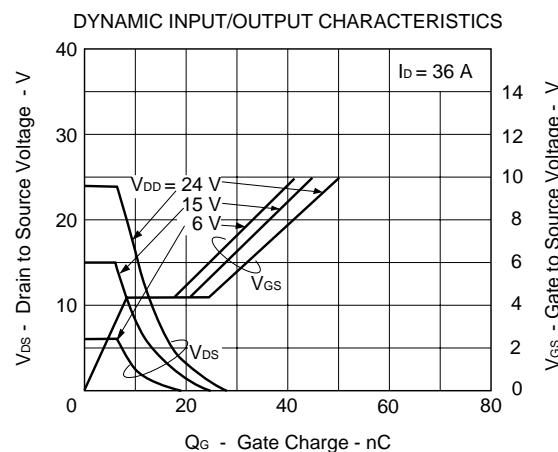
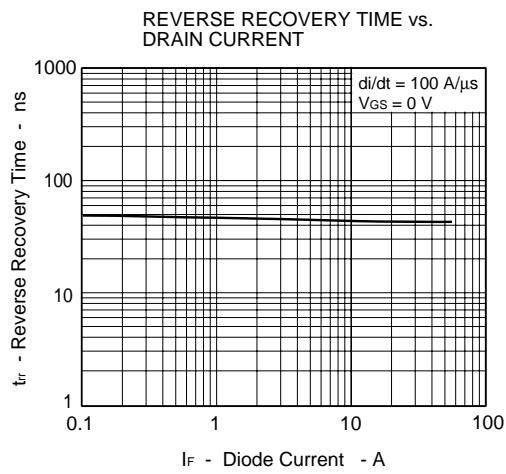
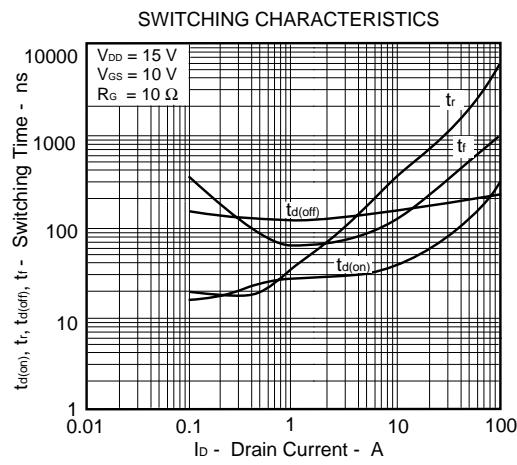
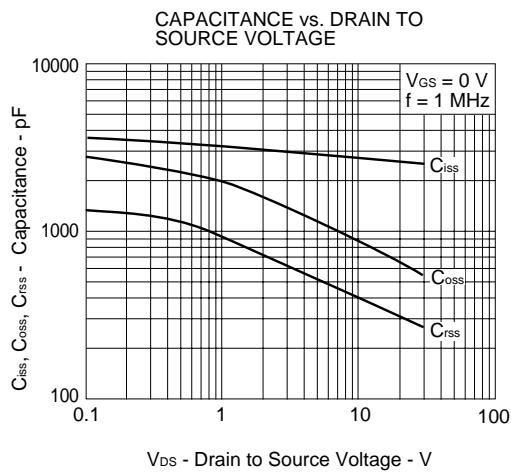
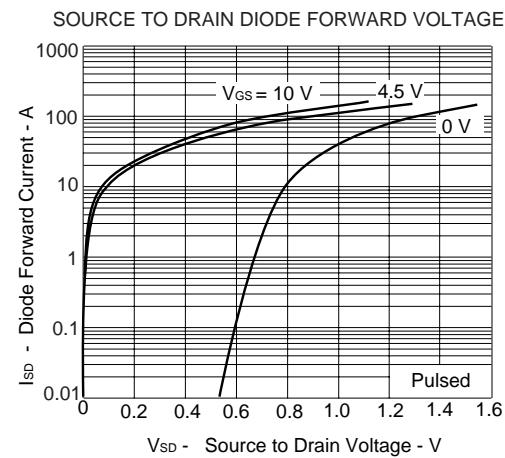
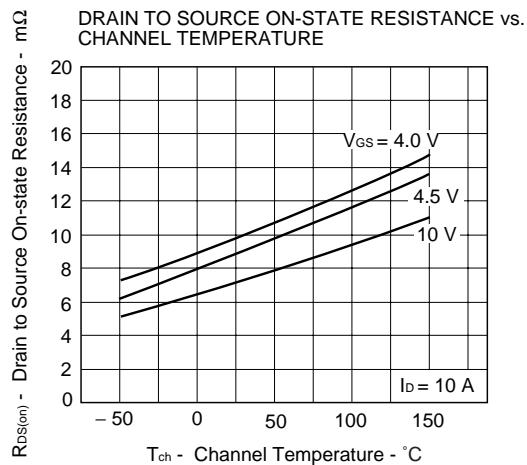


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



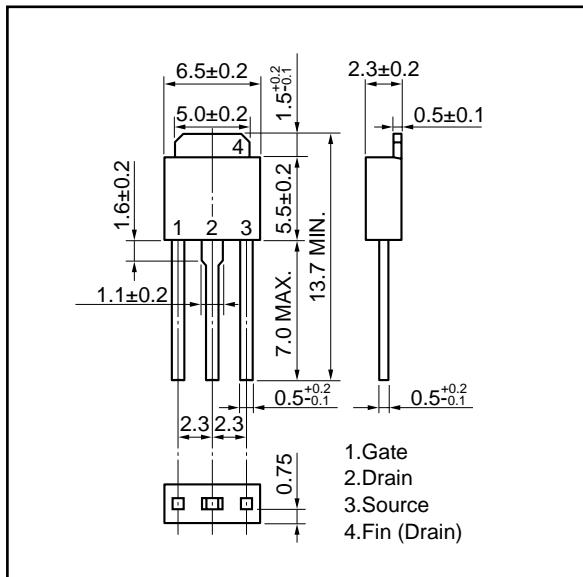
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



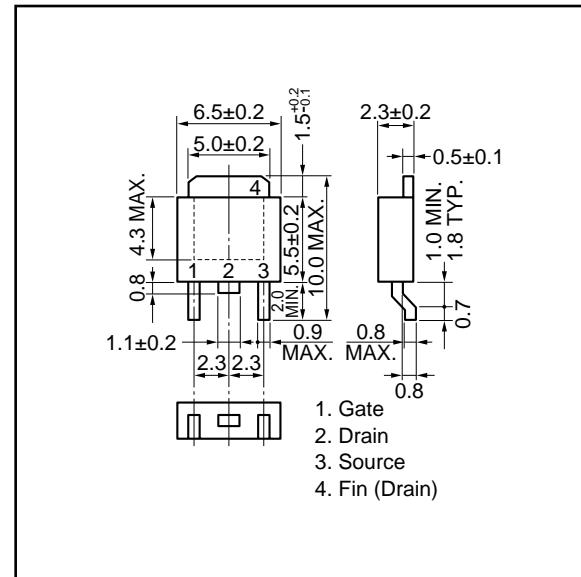


PACKAGE DRAWINGS (Unit : mm)

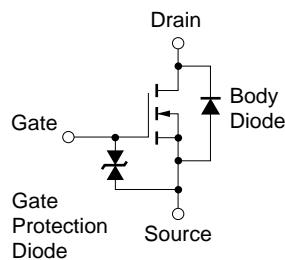
1) TO-251 (MP-3)



2) TO-252 (MP-3Z)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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